

# Vertiv™ CoolChip CDU

In-Rack Liquid-to-Liquid Coolant Distribution Unit



## Benefits

This energy and space efficient coolant distribution unit for High Performance Computing (HPC) and data center applications provides:

- Simple in-rack installation, occupying only 4U of rack space
- Localized liquid cooling loop to enable quick deployment of liquid cooling
- Essential separation of the primary (facility) water from the IT equipment to maintain high quality
- A large surface area heat exchanger to provide high cooling capacity with low approach temperatures
- Controlled secondary fluid circuit through differential pressure, meeting various application requirements
- Integrated secondary fluid filtration to extend system life and reduce risk of containments
- Secondary fluid temperature controlled within  $\pm 1^{\circ}\text{C}$ , to offer cooling stability with variable heat loads
- Global all-in-one service offerings from design to installation and startup to fluid management and trouble shooting
- Factory fitted with internal reservoir and fill pump for ease of maintenance
- CE, cULus, and RoHS Compliance



*The Vertiv™ CoolChip CDU 121 in-rack coolant distribution unit (CDU) provides effective separation of the facility fluid circuit and secondary fluid network via a liquid-to-liquid heat exchanger for single rack direct-to-chip cooling applications.*

### In-Rack Fluid Distribution

The Vertiv CoolChip delivers high-capacity cooling in a compact footprint that provides easy, cost-effective liquid cooling deployments in any data center application for high-density processes. This in-rack CDU makes it simple to deploy additional liquid cooled racks as businesses grow or for companies looking to test AI programs before making larger investments in full-scale systems.

Since the CDU serves a single rack, the secondary fluid circuit remains minimal, reducing data centre risk. With integrated controls to manage flowrate, pressure, and temperature, the fluid can be precisely maintained for exceptional quality at all times.

### Local and Remote Management

- 7" color touchscreen Human-Machine Interface (HMI)
- Communication via Modbus RTU (RS485) and TCP/IP
- Full alarm monitoring, providing real-time status of the IT equipment and ambient environment
- Remote monitoring and control capabilities
- Unit-to-unit communication available for increased redundancy and controlled coordination



## Technical Specifications

	AC Power Input	DC Power Input
<b>Physical Data</b>		
Unit Dimensions (H x W x D), m (in)	175 x 445 x 850 (6.89 x 17.52 x 33.46)	
Shipping Dimensions (H x W x D), m (in)	441 x 666 x 1096 (17.36 x 26.22 x 43.15)	
Weight (Dry), kg (lbs)	54 (119)	52.5 (116)
Weight (Wet), kg (lbs)	61.2 (135)	59.7 (132)
Weight (Shipping), kg (lbs)	89 (196)	86.5 (191)
<b>Performance Data</b>		
Nominal Cooling Capacity	121 kW @ 4°C Approach Temperature Difference (ATD)	
Nominal Fluid Flow (Secondary)	120 l/min @ 1.15 bar	
<b>Fluid Circuit Data</b>		
Fluid Type	Water or PG-25 with inhibitors	
Fluid Filtration	50µm or 25µm	
Primary Fluid Circuit Volume	3.4 L	
Secondary Fluid Circuit Volume	7.2 L	
Piping Connection	1.5 in. Sanitary Flange	
Connection Location	Rear	
<b>Electrical Data</b>		
Power Supply	110V-120V / 208V-240V, 1PH, 50/60 Hz	46 V- 52 VDC
FLA	7.6 A (at 115 V) / 3.8 A(at 230 V)	18 A
Nominal Power Consumption	875 W	860 W
Power Feed	Dual IEC C14	ORV3 Busbar Connector
<b>Ambient Conditions</b>		
Operating Conditions	5 to 45°C (41 - 113°F), 8 to 80% RH (non-condensing)	
Storage Conditions	-40 to 70°C (-40 to 158°F), 5 to 93% RH (non-condensing)	
<b>Compliance</b>		
Safety Compliance	CE, cULus, RoHS	